



PCM1740

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Sound Stereo Audio DIGITAL-TO-ANALOG CONVERTER with VCXO and PLL

FEATURES

COMPLETE DELTA-SIGMA STEREO DAC VOLTAGE-CONTROLLED CRYSTAL

OSCILLATOR: 27MHz ±150ppm Output with

0V to 3V Input

PROGRAMMABLE PLL

256f_S or 384f_S Audio System Clock Output

DYNAMIC PERFORMANCE:

Dynamic Range: 94dB

SNR: 94dB THD+N: 89dB

SAMPLING FREQUENCIES: 16kHz, 22.05kHz, 24kHz 32kHz, 44.1kHz, 48kHz 64kHz, 88.2kHz, 96kHz

SERIAL AUDIO INTERFACE: Standard or I²S Data Formats

16-, 20-, or 24-Bit Data

10-, 20-, OI 24-DIL Data

I²C-BUS INTERFACE FOR CONTROL

REGISTERS(1):

Slave Receiver Operation

7-Bit Addressing

Standard Transfer Rate (up to 100kbps)

PROGRAMMABLE CONTROLS:

Digital Attenuation (256 steps)

Soft Mute

Infinite Zero Detect Mute

De-Emphasis (32kHz, 44.1kHz, 48kHz)

DAC Output Mode

SINGLE +5V SUPPLY

SMALL SSOP-24 PACKAGE

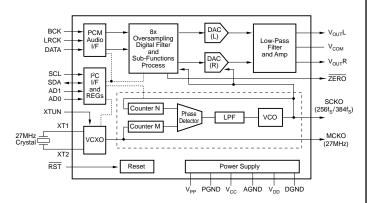
DESCRIPTION

The PCM1740 is a complete stereo audio digital-to-analog converter with on-chip PLL and VCXO. The PCM1740 is designed specifically for set-top box applications requiring high-quality audio playback, a precision tuned 27MHz master clock source, and support for multiple audio-sampling frequencies.

The stereo D/A converter utilizes multi-bit, delta-sigma architecture, which includes an 8x interpolation filter, third-order noise shaping, 5-level amplitude quantization, and an analog low-pass filter. The PCM1740 includes a number of user-programmable functions, which are accessed via a standard I²C-Bus interface.

APPLICATIONS

SET-TOP BOXES
DIGITAL BROADCAST RECEIVERS



NOTE: (1) I²C-Bus" is a registered trademark of Philips Semiconductor.

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SPECIFICATIONS

All specifications at $T_A = +25$ °C, $V_{CC} = V_{DD} = V_{PP} = 5.0$ V, $f_S = 44.1$ kHz, system clock = 384 f_S , 16-bit data, unless otherwise noted.

			PCM1740E		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RESOLUTION			16		Bits
DATA FORMAT					
Audio Interface Format			idard/I ² S Select		
Audio Data Bit Length		l l	5/20/24 Selectal		Bits
Audio Data Format	Standard (f.)	32	rst, Two's Binaı 44.1	ry Complement 48	kHz
Sampling Frequency (f _S)	Standard (f_S) Half (f_S)	16	22.05	24	kHz
	Double (f _S)	64	88.2	96	kHz
Internal System Clock Frequency			256f _S /384f _S		
DIGITAL INPUT/OUTPUT					
Logic Family	Input Logic		TTL Compatible		
High Level Input Voltage: V _{IH} (1), (2)		2.0			VDC
Low Level Input Voltage: V _{IL} (1), (2)				0.8	VDC
High Level Input Current: I _{IH} ^{(1), (2)}	$V_{IH} = V_{DD}$			±10	μΑ
Low Level Input Current:					
I _{IL} ⁽¹⁾	$V_{IL} = 0V$			±10	μΑ
I _{IL} (2)	$V_{IL} = 0V$			-120	μΑ
High Level Output Voltage: V _{OH} ⁽³⁾	$I_{OH} = -2mA$	$V_{DD} - 0.5V$			VDC
Low Level Output Voltage:				0.5	\/50
V _{OH} ⁽³⁾	$I_{OL} = 4mA$			0.5	VDC
V _{OL} ⁽⁴⁾	I _{OL} = 2mA			0.5	VDC
DIGITAL INPUT/OUTPUT of I ² C-BUS INTER	RFACE	1			
High Level Input Voltage: V _{IH} (5)		3.0			V
Low Level Input Voltage: V _{IL} (5)		-0.3		1.5	V
Low Level Output Voltage: V _{OL} ⁽⁶⁾		0		0.4 250	V ns
Output Fall Time: t _{OF} ⁽⁷⁾ Input Logic Current: I ₁ ⁽⁸⁾	10% to 90% of V _{DD}	-10		10	μA
Capacitance for each I/O pin: C _I ⁽⁵⁾	10% to 30% of V _{DD}	-10		10	pF
<u> </u>	27MHz Fundamental Crystal			10	Pi
VCXO CHARACTERISTICS (MCKO) Crystal Clock Frequency (9)	27MHz, Fundamental Crystal		27.0000		MHz
Crystal Clock Accuracy ⁽⁹⁾			±30		ppm
XTUN Tuning Voltage Range ⁽¹⁰⁾		0		3.0	V
XTUN Input Impedance(10)			60		kΩ
Output Clock Frequency	XTUN = 1.3V		27.0000		MHz
Output Clock Accuracy	XTUN = 1.3V		±50		ppm
VCXO Tuning Range Output Clock Duty Cycle	XTUN = 0V - 3V 10pF Load	35	300 45	55	ppm %
Output Clock Jitter	Standard Deviation	33	100	33	ps
Output Rise Time	20% to 80% V _{DD} , 10pF Load		4		ns
Output Fall Time	80% to 20% V _{DD} , 10pF Load		4		ns
Response Time ⁽¹¹⁾				10	μs
Power Up Time ⁽¹²⁾				5	ms
PLL AC CHARACTERISTICS (SCKO)					
Output Clock Frequency	MCKO = 27.0MHz	4.096	50	36.864	MHz
Output Clock Duty Cycle Output Clock Jitter	10pF Load Standard Deviation	40	50 150	60	% ps
Output Rise Time	20% to 80% V _{DD} , 10pF Load		4		ns
Output Fall Time	80% to 20% V _{DD} , 10pF Load		4		ns
Frequency Transition Time(13)				20	ms
Power Up Time ⁽¹⁴⁾			15	30	ms
DYNAMIC PERFORMANCE(15)					
THD+N:					
$V_{OUT} = 0dB$	f _S = 44.1kHz		0.0035	0.01	%
	$f_S = 96kHz$		0.007		%
$V_{OUT} = -60 dB$	f _S = 44.1kHz		0.0035	0.01	%
Dynamic Range	$f_S = 96kHz$ $f_S = 44.1kHz$, EIAJ, A-Weighted	90	0.007 94		% dB
Dynamic Nange	$f_S = 44.1$ kHz, EIAJ, A-vveighted $f_S = 96$ kHz, A-Weighted	90	90		dВ
Signal-to-Noise Ratio ⁽¹⁶⁾	f _S = 44.1kHz, EIAJ, A-weighted	90	94		dB
	$f_S = 96kHz$, A-weighted		90		dB
Channel Separation	$f_S = 44.1 \text{kHz}$	88	92		dB
Lavallia anita Fara	$f_S = 96kHz$		88		dB
Level Linearity Error	$V_{OUT} = -90dB$		±1.0		dB



SPECIFICATIONS

All specifications at T_A = +25°C, V_{CC} = V_{DD} = V_{PP} = 5.0V, f_S = 44.1kHz, system clock = 384f_S, 16-bit data, unless otherwise noted.

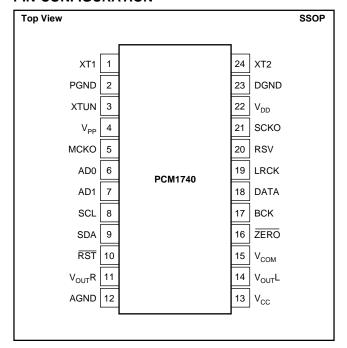
			PCM1740E		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
DC ACCURACY					
Gain Error			±1.0	±3.0	% of FSR
Gain Mismatch, Channel-to-Channel			±1.0	±3.0	% of FSR
Bipolar Zero Error			±1.0		% of FSR
ANALOG OUTPUT					
Voltage Range	Full Scale (0dB)		0.62 V _{CC}		Vp-p
Center Voltage			0.5 V _{CC}		VDC
Load Impedance	AC Coupled	5			kΩ
DIGITAL FILTER PERFORMANCE					
Passband				0.445 f _S	Hz
Stopband		0.555 f _S			Hz
Passband Ripple				±0.17	dB
Stopband Attenuation		-35			dB
De-Emphasis Error		-0.2		+0.55	dB
Delay Time			11.125/f _S		sec
ANALOG FILTER PERFORMANCE					
Frequency Response	20Hz to 20kHz		-0.16		dB
	20Hz to 40kHz		-0.6		dB
POWER SUPPLY REQUIREMENTS					
Voltage Range	V_{DD} , V_{CC} , V_{PP}	+4.5	+5	+5.5	VDC
Supply Current, I _{DD} + I _{CC} + I _{PP}	$V_{DD} = V_{CC} = V_{PP} = +5V$		25	30	mA
Power Dissipation	$V_{DD} = V_{CC} = V_{PP} = +5V$		125	150	mW
TEMPERATURE RANGE					
Operation		-25		+85	°C
Storage		-55		+125	°C
Thermal Resistance, θ_{JA}			100		°C/W

NOTES: (1) Pins 6, 7, 18, 19: AD0, AD1, BCK, DATA, LRCK (Schmitt trigger input). (2) Pin 10: $\overline{\text{RST}}$ (Schmitt trigger input with internal pull-up resistor). (3) Pins 5, 21: MCKO, SCKO. (4) Pin 16: $\overline{\text{ZERO}}$ (open drain output). (5) Pins 8, 9: SCL, SDA. (6) Pin 9: SDA (open drain output, I_{OL} = 3mA). (7) Pin 9: SDA (from V_{IHMIN} to V_{ILMAX} with a bus capacitance from 10pF to 400pF). (8) Pins 8, 9: SCL, SDA (input current each I/O pin with an input voltage between 0.1 V_{DD} and 0.9 V_{DD}). (9) This characteristic is the requirement for crystal oscillator. (10) Pin 3: XTUN. (11) The maximum response time when the XTUN is changed. (12) The maximum delay time from power on to oscillation. (13) The maximum lock up time when the PLL frequency is changed. (14) The maximum delay time from power on to lock up. (15) Dynamic performance specifications are tested with a 20kHz low-pass filter using a Shibasoku distortion analyzer 725°C with 30kHz LPF, 400Hz HPF, Average-Mode. (16) SNR is tested with infinite zero detection circuit disabled.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.



PIN CONFIGURATION



PIN ASSIGNMENTS

PIN	NAME	1/0	FUNCTION						
1	XT1	_	27MHz Crystal connection.						
2	PGND	-	PLL and VCXO ground.						
3	XTUN	IN	VCXO tune, tuning voltage range from 0V to 3V.						
4	V_{PP}	_	PLL and VCXO power supply, +5V.						
5	MCKO	OUT	Buffered clock output of VCXO.						
6	AD0	IN	Device address pin for I ² C-BUS. ⁽¹⁾						
7	AD1	IN	Device address pin for I ² C-BUS. ⁽¹⁾						
8	SCL	IN	Bit clock input for I ² C-BUS interface.						
9	SDA	IN/OUT	Serial data for I ² C-BUS interface.						
10	RST	IN	Reset, active LOW.(2)						
11	$V_{OUT}R$	OUT	Right-channel analog voltage output.						
12	AGND	-	Analog ground.						
13	V _{CC}	-	Analog power supply, +5V.						
14	$V_{OUT}L$	OUT	Left-channel analog voltage output.						
15	V_{COM}	_	DC common-mode voltage output.						
16	ZERO	OUT	Zero flag output, active LOW.(3)						
17	BCK	IN	Bit clock input for serial audio data.(1)						
18	DATA	IN	Serial audio data input.(1)						
19	LRCK	IN	Left and right word clock, equal to the sampling rate ($f_{\rm S}$). ⁽¹⁾						
20	RSV	-	Reserved must be open.						
21	SCKO	OUT	System clock output, 256/384 f _S .						
22	V_{DD}	-	Digital power supply, +5V.						
23	DGND	-	Digital ground.						
24	XT2	<u> </u>	27MHz Crystal connection.						

NOTES: (1) Schmitt trigger input. (2) Schmitt trigger input with internal pull-up resistor. (3) Open drain output.

ABSOLUTE MAXIMUM RATINGS

Power Supply Voltage ⁽¹⁾	+6.5V
Supply Voltage Differences ⁽²⁾	±0.1V
GND Voltage Differences(3)	±0.1V
Digital Input Voltage	–0.3V to (V _{DD} + 0.3V)
Analog Input Voltage	0.3V to (V _{CC} + 0.3V)
Input Current (any pins except supplies)	±10mA
Operating Temperature Range	–25°C to +85°C
Storage Temperature	–55°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering, 5s)	+260°C
Package Temperature (IR reflow, peak, 10s)	+235°C

NOTES: (1) V_{CC} , V_{DD} , V_{PP} . (2) Among V_{CC} , V_{DD} , V_{PP} . (3) Among AGND, DGND, and PGND. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

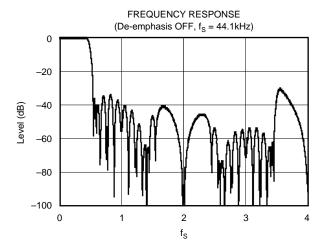
PACKAGE/ORDERING INFORMATION

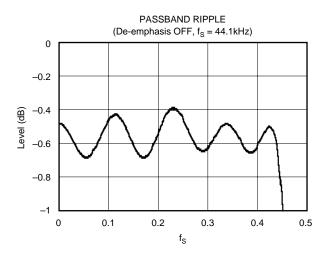
PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA
PCM1740E	SSOP-24	338	-25°C to +85°C	PCM1740E	PCM1740E	Rails
"	"	"	n n	PCM1740E	PCM1740E/2K	Tape and Reel

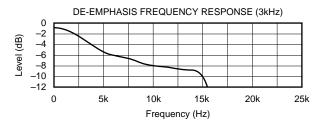
NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K indicates 2000 devices per reel). Ordering 2000 pieces of "PCM1740E/2K" will get a single 2000-piece Tape and Reel.

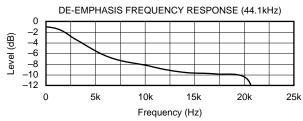
TYPICAL PERFORMANCE CURVES

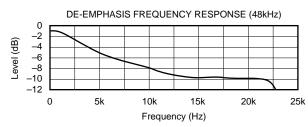
At $T_A = +25^{\circ}\text{C}$, $V_{CC} = V_{DD} = +5\text{V}$, $f_S = 44.1\text{kHz}$, $F_{SCKO} = 384f_S = 16.9344\text{MHz}$, and 16-bit data, unless otherwise noted.

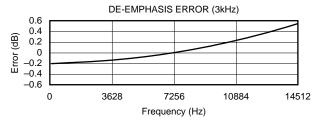


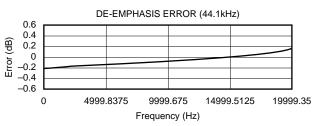


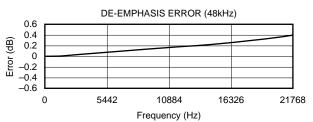






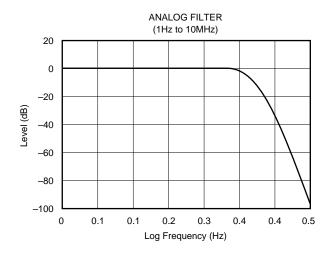


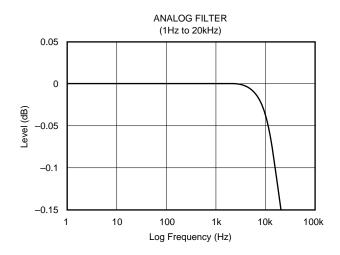


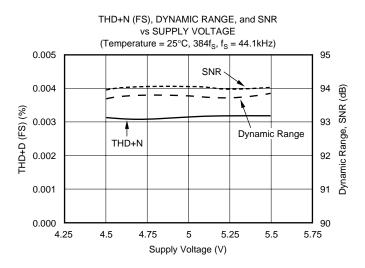


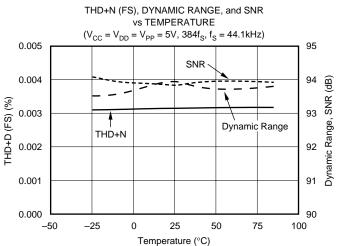
TYPICAL PERFORMANCE CURVES (Cont.)

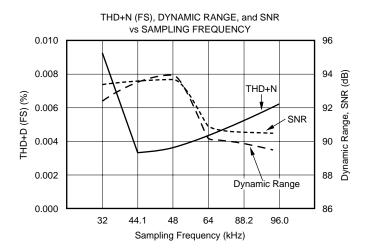
At $T_A = +25^{\circ}C$, $V_{CC} = V_{DD} = +5V$, $f_S = 44.1$ kHz, $F_{SCKO} = 384f_S = 16.9344$ MHz, and 16-bit data, unless otherwise noted.

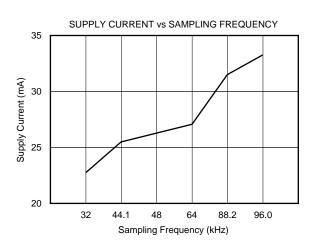












STEREO DIGITAL-TO-ANALOG CONVERTER

The stereo D/A converters of the PCM1740 utilize a multilevel delta-sigma architecture. Based upon a third-order noise shaper and a 5-level amplitude quantizer, this section converts the 8x oversampled, 18-bit input data from the interpolation filter to a 5-level delta-sigma format. A block diagram of the multi-level delta-sigma modulator is shown in Figure 1. This architecture has the advantage of improved stability and increased tolerance to clock jitter when compared to the one-bit (2-level) delta-sigma D/A converters.

The combined oversampling rate of the delta-sigma modulator and the 8x interpolation filter is $48f_{\rm S}$ for a $384f_{\rm S}$ system clock, and $64f_{\rm S}$ for a $256f_{\rm S}$ system clock. The theoretical quantization noise performance for the 5-level delta-sigma modulator is shown in Figure 2.

The output of the delta-sigma modulator is low-pass filtered and buffered by an on-chip output amplifier. For best performance, an external low-pass filter is recommended. Refer to the "Applications Information" section of this data sheet for details regarding DAC output filter recommendations.

The PCM1740 includes two analog outputs, $V_{OUT}L$ (pin 14) and $V_{OUT}R$ (pin 11), corresponding to the left and right audio outputs. The full-scale output amplitude is $0.62 \cdot V_{CC}$, or 3.1Vp-p with a +5V supply and an AC coupled load of $5k\Omega$ or greater. The analog outputs are centered about the DC common mode voltage, which is typically $V_{CC}/2$.

The DC common-mode voltage is made available at the V_{COM} output (pin 15). This is an unbuffered output, prima-

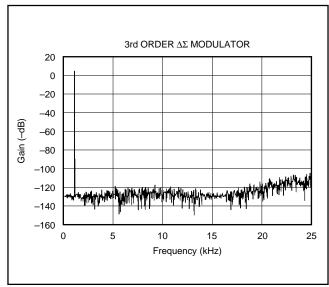


FIGURE 2. Quantization Noise Spectrum.

rily used for de-coupling purposes. See the "Applications Information" section of this data sheet for more information regarding the use of the V_{COM} output for biasing external circuitry.

VOLTAGE CONTROLLED CRYSTAL OSCILLATOR (VCXO)

The PCM1740 includes an on-chip voltage-controlled crystal oscillator, or VCXO, which is used to generate the 27MHz master clock required by most digital broadcast and MPEG-2 decoding applications.

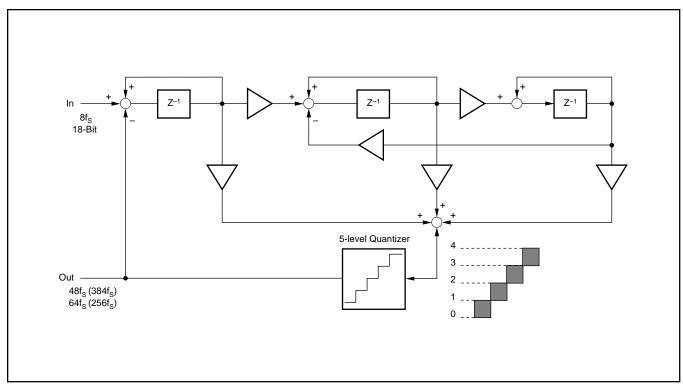


FIGURE 1. 5-Level $\Delta\Sigma$ Modulator Block Diagram.

The 27MHz clock is available at the MCKO output (pin 5). The VCXO output frequency can be precisely tuned using a control voltage at the XTUN input (pin 3). The tuning range is 27MHz ±150ppm typical for a 0V to +3V control voltage range. Figure 3 shows the VCXO equivalent circuit, while Figure 4 shows the typical tuning curve.

At power up, the VCXO requires 5ms start up time. The VCXO also exhibits a $10\mu s$ settling time in response to changes in the XTUN control voltage. VCXO operation and the MCKO output are not effected by the power on or external reset functions, continuing to operate during the initialization sequence.

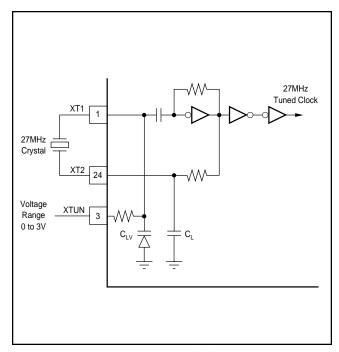


FIGURE 3. VCXO Equivalent Circuit.

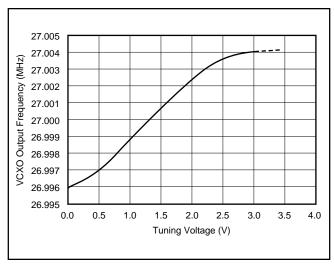


FIGURE 4. VCXO Output Frequency (MCKO) versus Tuning Voltage (XTUN).

Crystal Selection

The VCXO connects to an external 27MHz crystal via XT1 (pin 1) and XT2 (pin 24). The crystal should be AT-cut, fundamental mode with $\pm 30 ppm$ accuracy and less than 50Ω motional resistance. Crystal shunt capacitance should be 3pF maximum, while load capacitance should be less than 7pF. Miniature lead type or surface-mount devices are recommended. External load capacitors are not needed, since they are provided on-chip. The crystal should be placed as close as possible to the XT1 and XT2 pins to reduce effects of parasitic capacitance and land resistance.

PROGRAMMABLE PHASE LOCKED LOOP (PLL)

The PCM1740 includes an on-chip PLL for generating a $256f_S$ or $384f_S$ audio system clock from the 27MHz VCXO output. A block diagram of the PLL section is shown in Figure 5. The PLL output clock is used by the digital filter and delta-sigma modulator circuitry, and is made available at the SCKO output (pin 21) for use with additional audio converters and signal processors.

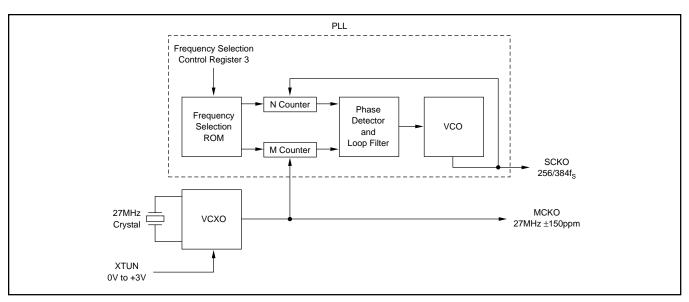


FIGURE 5. PLL Block Diagram.



The PLL can generate one of nine pre-programmed system clock rates for either $256f_S$ or $384f_S$ output. The PLL output and sampling frequencies are programmed using Control Register 3. Table I shows the available sampling frequencies and the corresponding PLL output clock rates. The reset default condition for the PLL is $f_S = 44.1 \text{kHz}$ with SCKO = $384f_S$, or 16.9344 MHz.

At power up, the PLL requires 30ms start up time for stabilization. The PLL also exhibits a settling time of 20ms in response to changes in sampling frequency selection. The PLL output continues to operate during power on or external reset sequences, with the sampling frequency set to $f_S = 44.1 \text{kHz}$ and SCKO = $384f_S$.

SAMPLING FREQUENCY (LRCK)		INTERNAL SYSTEM Clock - 256f _S	INTERNAL SYSTEM Clock - 384f _S
16kHz	Half	4.096MHz	6.144MHz
32kHz	Normal	8.192MHz	12.288MHz
64kHz	Double	16.384MHz	24.576MHz
22.05kHz	Half	5.6448MHz	8.4672MHz
44.1kHz	Normal	11.2896MHz	16.9344MHz
88.2kHz	Double	22.5792MHz	33.8688MHz
24kHz	Half	6.144MHz	9.216MHz
48kHz	Normal	12.288MHz	18.432MHz
96kHz	Double	24.576MHz	36.864MHz

TABLE I. PLL Sampling and System Clock Frequencies.

RESET OPERATION

POWER ON RESET

The PCM1740 includes power-on reset circuitry for start up initialization. The initialization sequence starts when V_{DD} exceeds 2.2V (typical). The initialization sequence requires 1024 PLL output (or SCKO) clock cycles for completion. During initialization, both $V_{OUT}L$ and $V_{OUT}R$ are forced to $V_{CC}/2$. Figure 6 shows the power on reset timing, while Table II shows the reset default settings for user-programmable functions. The user should not attempt to write control registers via the $I^2C\text{-Bus}$ interface during the initialization sequence.

EXTERNAL RESET

The PCM1740 includes an external reset input, \overline{RST} (pin 10). This input may be used to force an initialization sequence. As shown in Figure 7, the \overline{RST} pin must be held low for a minimum of 20ns. The initialization sequence will then start on the rising edge of \overline{RST} . Initialization requires 1024 PLL output (or SCKO) clock cycles for completion. During initialization, both $V_{OUT}L$ and $V_{OUT}R$ are forced to $V_{CC}/2$. Table II shows the reset default settings for user-programmable functions. The user should not attempt to write control registers via the I²C-Bus interface during the initialization sequence.

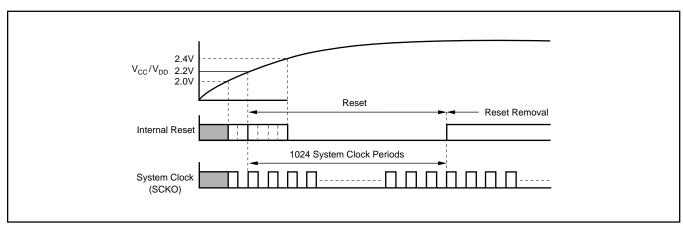


FIGURE 6. Power-On Reset Operation.

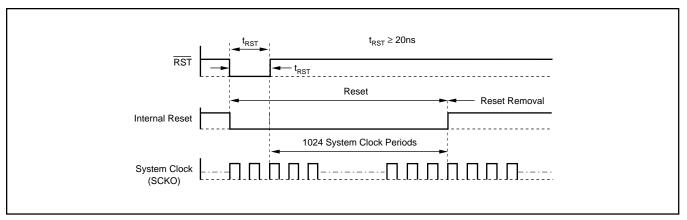


FIGURE 7. External Reset Operation.

ZERO FLAG OUTPUT

The PCM1740 includes a zero flag output, \overline{ZERO} (pin 16). This is an open-drain output, and a $10k\Omega$ pull-up resistor connected to V_{DD} is recommended when using the \overline{ZERO} flag as a logic output.

The PCM1740 includes an infinite zero detection function that monitors the audio data at the DATA input (pin 18). If the audio data for both the left and right channels is all zeros for 65,536 continuous BCK clock cycles, the zero flag will be activated, turning on a MOSFET switch and connecting the $\overline{\text{ZERO}}$ pin to ground. This provides an active low output that may be used to control an external mute circuit, or as a logic indicator for an audio DSP/decoder or microprocessor.

AUDIO SERIAL INTERFACE

The PCM1740 includes a three-wire serial audio interface. This includes LRCK (pin 19), BCK (pin 17), and DATA (pin 18). The LRCK input is the audio left/right clock, which is used as a latch signal for the interface. The BCK input is used to clock audio data into the serial port. The DATA input carries multiplexed data for the left and right audio channels. Audio data must be Two's Complement, MSB first formatted. Figure 8 shows the typical connection between the PCM1740 audio serial interface and an audio DSP or decoder.

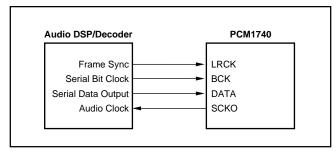


FIGURE 8. Interfacing the PCM1740 to an Audio DSP.

The LRCK input is operated at the sampling frequency, f_S . The BCK input is operated at 32, 48, or 64 times the sampling frequency. Both LRCK and BCK must be synchronous with the SCKO output for proper operation.

Data Formats

The PCM1740 supports two audio interface formats: Standard and I²S. These formats are shown in Figure 9. The audio data word length for the Left and Right channels may be 16-, 20-, or 24-bits. The audio data word length and format are programmed using Control Registers 2 and 3. The reset default condition is Standard format with 16-bit audio data.

Timing Requirements

Figure 10 shows the audio interface timing requirements.

LRCK and BCK Rates

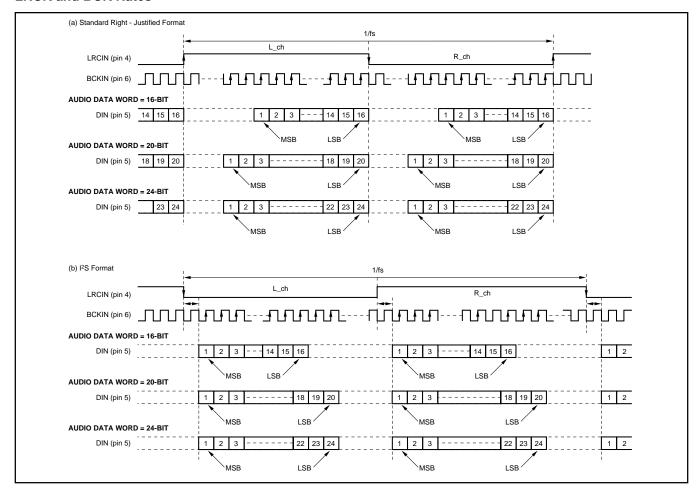


FIGURE 9. Audio Interface Formats.



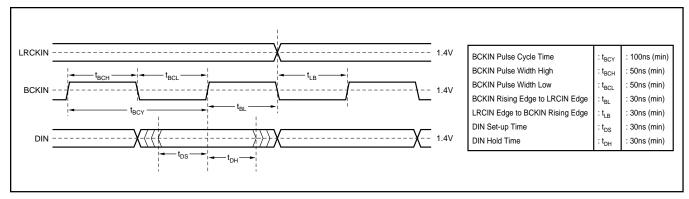


FIGURE 10. Audio Interface Timing.

Loss of Synchronization

Ideally, LRCK and BCK will be derived from the SCKO output, ensuring synchronous operation. For other cases, the PCM1740 includes circuitry to detect loss of synchronization between the LRCK and the system clock, SCKO. A loss of synchronization condition is detected when the phase relationship between SCKO and LRCK exceeds ± 6 BCK cycles during one sample period, or $1/f_{\rm S}$. If a loss of synchronization condition is detected, the DAC operation will halt within one sample period and the analog outputs will be forced to $V_{\rm CC}/2$ until re-synchronization between LRCK and SCKO is completed. Figure 11 shows the state of the analog outputs given a loss of synchronization event. During the undefined states, as well as transitions between normal and undefined states, the analog outputs may generate audible noise.

USER PROGRAMMABLE FUNCTIONS

The PCM1740 includes a number of programmable functions, which are configured using five control registers. These registers are accessed using the I²C-Bus interface.

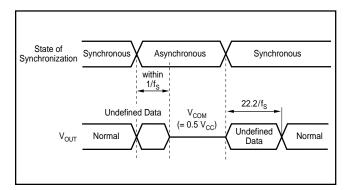


FIGURE 11. Loss of Synchronization and Analog Output State.

This section describes the control registers, while the I²C-Bus interface is described in a later section. Table II lists the available functions and their corresponding reset default condition.

Register Map

The control register map is shown in Table III. Sub-address bits B8 through B10 are used to specify the register that is being written. All reserved bits, shown as "res", must be set to '0'.

Register Descriptions

The following pages provide detailed descriptions of the five control registers and their associated functions. All reserved bits, shown as "res", must be set to '0'.

FUNCTION	MODE BY DEFAULT
Audio Data Format Select: Standard Format/I ² S Format	Standard Format
Audio Data Word Select: 16-Bit/20-Bit/24-Bit	16-Bit
Polarity of LR-clock Selection	Left/Right = HIGH/LOW
De-emphasis Control: OFF, 32kHz, 44.1kHz, 48kHz	OFF
Soft Mute Control	OFF
Attenuation Data for Left-channel	0dB
Attenuation Data for Right-channel	0dB
Attenuation Data Mode Control	Left-channel, Right-channel Individually
Analog Output Mode Select	Stereo Mode
Infinity Zero Detect Mute Control	OFF
DACs Operation Control	ON
System Clock Select: 256f _S /384f _S	384f _S
Sampling Frequency Select: 32kHz Group, 44.1kHz Group, 48kHz Group	44.1kHz Group
Sampling Frequency Multiplier: Normal/Double/Half	Normal, x1

TABLE II. User-Programmable Functions.

		SUB ADDRESS BYTE									DATA BYTE						
REGISTER	B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	B5	В4	В3	B2	B1	В0	
Register 0	res	res	res	res	res	A2	A1	A0	AL7	AL6	AL5	AL4	AL3	AL2	AL1	AL0	
Register 1	res	res	res	res	res	A2	A1	A0	AR7	AR6	AR5	AR4	AR3	AR2	AR1	AR0	
Register 2	res	res	res	res	res	A2	A1	A0	PL3	PL2	PL1	PL0	IW1	IW0	DEM	MUT	
Register 3	res	res	res	res	res	A2	A1	A0	SF1	SF0	DSR1	DSR0	SYS	ATC	LRP	IIS	
Register 4	res	res	res	res	res	A2	A1	A0	res	res	res	res	res	OPE	IZD	LD	

TABLE III. Control Register Map.

REGISTER DEFINITIONS

Register 0

B15	B14	B13	B12	B11	B10	В9	B8	B7	B6	B5	B4	В3	B2	B1	В0
res	res	res	res	res	0	0	0	AL7	AL6	AL5	AL4	AL3	AL2	AL1	AL0

Left Channel Attenuation Data

Default: $AL[7:0] = FF_{HEX}$

Register 0 is used to set the digital attenuation level for the Left Channel. If the ATC bit in Register 3 is set to "1", then this data is also used to control the Right Channel attenuation. The attenuation level is defined by the following relationships:

Attenuation (dB) = $20 \times \log (AL[7:0]_{DEC} \div 256)$, when $AL[7:0] = 01_{HEX} (1_{DEC})$ through $FE_{HEX} (254_{DEC})$

Attenuation (dB) = $-\infty$ (or Mute), when AL[7:0] = 00_{HEX}

Attenuation (dB) = 0dB, when $AL[7:0] = FF_{HEX}$

The Attenuation Load bit, LD, in Register 4 must be set to "1" in order to update attenuation settings.

If LD is set to "0", the attenuation remains at the previously programmed level, ignoring the new data until LD is set to "1".

B15 B14 B13 B12 B11 B10 В9 **B8** В7 **B6 B5 B4** ВЗ B0 1 AR7 AR6 AR5 AR4 AR3 AR2 AR1 AR0 Register 1 res res res n res res

Right Channel Attenuation Data

Default: $AR[7:0] = FF_{HEX}$

Register 1 is used to set the digital attenuation level for the Right Channel. If the ATC bit in Register 3 is set to '1', then the Left Channel attenuation data in Register 1 is used to control the Right Channel attenuation. The attenuation level is defined by the following relationships:

Attenuation (dB) = $20 \times \log (AR[7:0]_{DEC} \div 256)$, when $AR[7:0] = 01_{HEX} (1_{DEC})$ through $FE_{HEX} (254_{DEC})$

Attenuation (dB) = $-\infty$ (or Mute), when AR[7:0] = 00_{HEX}

Attenuation (dB) = 0dB, when $AR[7:0] = FF_{HEX}$

The Attenuation Load bit, LD, in Register 4 must be set to 1 in order to update attenuation settings.

If LD is set to "0", the attenuation remains at the previously programmed level, ignoring the new data until LD is set to "1".

B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 **B**1 B₀ Register 2 res PL3 PL2 PL1 PL0 IW1 IW0 DEM MUT res res res res

MUT Soft Mute Control

The MUT bit controls the soft mute function. Soft mute changes the digital attenuation level for both the Left and Right channels, stepping from the currently programmed value to infinite attenuation one step per sample period, or $1/f_S$. This provides a quiet muting of the outputs without audible noise.

MUT = 0 Soft Mute Disabled (default)
MUT = 1 Soft Mute Enabled

DEM Digital De-Emphasis

The DEM bit controls the digital de-emphasis function, which is valid only for 32kHz, 44.1kHz, and 48kHz sampling frequencies. The de-emphasis plots are shown in the Typical Performance Curves section of this data sheet.

DEM = 0 De-Emphasis OFF (default)
DEM = 1 De-Emphasis ON

IW0 Audio Data Word Length

IW1

The IW0 and IW1 bits are used to select the data word length for the audio serial interface.

The audio data format is selected using the IIS bit in Register 3.

IW1	IW0	Word Length
0	0	16-bits (default)
0	1	20-bits
1	0	24-bits
1	1	Reserved

PL[3:0] Analog Output Mode Select

Bits PL[3:0] are used to set the output mode for the analog outputs. Refer to the table below.

PL3	PL2	PL1	PL0	•	V _{OUT} L V _{OUT} R		Not	tes						
0	0	0	0	N	A ute		Mute		Mu	te				
0	0	0	1	Left Mute										
0	0	1	0	F	Right		Mute							
0	0	1	1	(L+R)/2		Mute							
0	1	0	0	N	A ute		Left							
0	1	0	1	I	.eft		Left							
0	1	1	0	F	Right Left				Reverse					
0	1	1	1	((L+R)/2 Left									
1	0	0	0	Mute Right										
1	0	0	1	I	.eft		Right		Ster	reo (de	fault)			
1	0	1	0	F	Right		Right							
1	0	1	1	(L+R)/2		Right							
1	1	0	0	N	A ute		(L+R)/2							
1	1	0	1	I	.eft		(L+R)/2							
1	1	1	0	F	Right		(L+R)/2							
1	1	1	1	((L+R)/2		(L+R)/2		Mo	no				
B15	B14 B13	B B12 B	11 B10	B9 B8	В7	В6	В5	В4	В3	В2	В1	В0		

Register 3

IIS

Audio	Data	Format	

res

res

res

res

res

The IIS bit is used to select the audio data format, either Standard Right Justified or I2S.

0

IIS = 0	Standard Right Justified (default)
IIS = 1	I^2S

SF1

SF0

DSR1

DSR0

SYS

ATC

LRP

IIS

LRP LRCK Polarity

The LRP bit selects the polarity of left/right clock input (LRCK) when using the Standard Right Justified audio data format. This bit has no effect when using the I²S audio data format.

LRP = 0	Left Channel when LRCK = High; Right Channel when LRCK = Low (default)
LRP = 1	Left Channel when LRCK = Low; Right Channel when LRCK = High

ATC Attenuation Mode Control

The ATC bit is used to select independent or common attenuation data for the Left and Right channels.

ATC = 0	Independent: Left Channel uses Register 0 and Right Channel uses Register 1 (default)
ATC = 1	Common: Left and Right Channels both use Register 0

SYS Audio System Clock (or SCKO)

The SYS bit is used to select the system clock (or SCKO) frequency, either 256f_s or 384f_s.

SYS = 0	384f _S (default)
SYS = 1	$256f_S$

DSR0

Sampling Frequency Multiplier

DSR₁

The DSR0 and DSR1 bits are used to select the multiplier used in conjunction with the SF0 and SF1 bits.

DSR1	DSR0	Multiplier
0	0	Normal, x1 (default)
0	1	Double, x2
1	0	Half, x 1/2
1	1	Reserved

SF0

Sampling Frequency Select

SF1

The SF0 and SF1 bits are used to select the sampling frequency group (32kHz, 44.1kHz, or 48kHz). The DSR0 and DSR1 bits, described previously, are used to select the multiplier.

SF1	SF0	Sampling Frequency Group
0	0	44.1kHz Group (22.05kHz, 44.1kHz, or 88.2kHz) (default)
0	1	48 kHz Group (24kHz, 48kHz, or 96kHz)
1	0	32 kHz Group (16kHz, 32kHz, or 64kHz)
1	1	Reserved

Register 4

B15	B14	B13	B12	B11	B10	В9	B8	B7	B6	B5	B4	В3	B2	B1	В0
res	res	res	res	res	1	0	0	res	res	res	res	res	OPE	IZD	LD

LD Attenuation Data Load Control

The LD bit is used to simultaneously set the Left and Right digital attenuation data. When LD is set to "1", the digital attenuation data given by Registers 0 and 1 is loaded for the Left and Right channels. When LD is set to "0", updates to Registers 0 and 1 are ignored, and the attenuation settings remain as previously programmed until LD is set to "1".

LD = 0	Disabled
LD = 1	Enabled: Left and Right Attenuation Data Updated Simultaneously

IZD Infinite Zero Detect Mute

The IZD bit is used to enable/disable the infinite zero detect mute function. The PCM1740 includes infinite zero detection logic that monitors the audio data at the DATA input (pin 18). If the audio data for both the Left and Right channels is all zeros for 65,536 continuous BCK clock cycles, the zero flag will be activated and output amplifier will be disconnected from the output of the delta-sigma modulator. The output amplifier's input is switched to the DC common mode voltage. This forces $V_{OUT}L$ and $V_{OUT}R$ to $V_{CC}/2$. The \overline{ZERO} output flag (pin 16) is not affected by the setting of this bit.

IZD = 0	Disabled (default)
IZD = 1	Enabled

OPE DAC Operation Control

The OPE bit is used to enable/disable the operation of the D/A converters. When enabled, the DAC outputs are connected to the output amplifier for normal operation. When disabled, the output amplifier is disconnected from the DAC output and switched to the DC common mode voltage. This forces $V_{OUT}L$ and $V_{OUT}R$ to $V_{CC}/2$.

OPE = 0 Enabled: Normal Operation(default) OPE = 1 Disabled: Outputs forced to $V_{CC}/2$

I²C-BUS INTERFACE DESCRIPTION

The PCM1740 includes an I²C-Bus interface for writing the internal control registers. This provides an industry standard method for interfacing a host CPU control port to the PCM1740. The PCM1740 operates as a Slave receiver on the bus, and supports data transfer rates up to 100 kilobits-per-second (kbps).

The I²C-Bus interface is comprised of four signals: SDA (pin 9), SCL (pin 8), AD0 (pin 6), and AD1 (pin 7). The SCL input is the serial data clock, while SDA is the serial data input. SDA carries start/stop, slave address, sub-address (or register address), register, and acknowledgment data. The AD0 and AD1 inputs form the lower two bits of the slave address.

Slave Address

The PCM1740 Slave address consists of seven bits, as shown in Figure 12. The five most significant bits are fixed, while the two least significant bits, named A0 and A1, are defined by the logic levels present at the AD0 and AD1 input pins. This allows four PCM1740Õs to reside on the same ‡C-Bus.

Bus Operation

Figure 13 shows the typical configuration of the PCM1740 on the I²C-Bus. The Master transmitter or transmitter/receiver is typically a microcontroller, or an audio DSP/decoder. The Master device controls the data transfers on the bus. The PCM1740 operates as a Slave receiver, and accepts data from the Master when it is properly addressed. The data transfer may be comprised of an unlimited number of bytes, or 8-bit data words. Figure 14 shows the message transfer protocol.

For normal bit transfer on the bus, data on SDA must be static while SCL is High. Data on SDA may change High/Low states when SCL is Low. The exception to this rule is the Start and Stop conditions.

The Start condition is defined by a High-to-Low transition on SDA while SCL is High, and is denoted with an ÒSÓ in Figure 12. The Stop condition is defined by a Low-to-High transition on SDA while SCL is High, and is denoted with a ÒPÓ in Figure 12. The Start and Stop conditions are always generated by the Master. All data transfers from Master to Slave begin with a Start condition and end with a Stop condition. The bus is considered to be busy after the Start condition, and becomes free some time after the Stop condition.

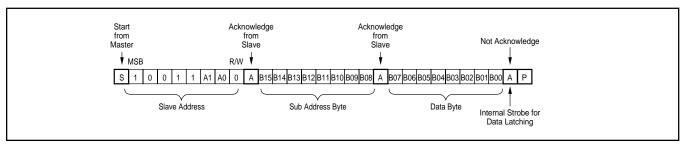


FIGURE 12. Control Data Format.

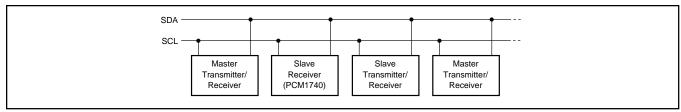


FIGURE 13. Typical I²C-Bus Configuration.

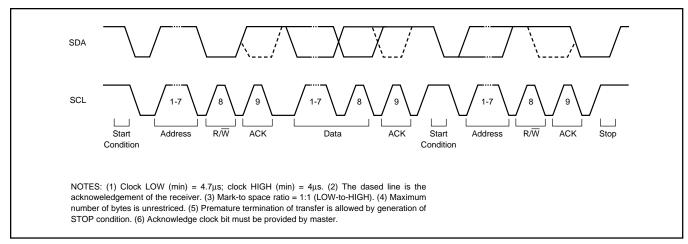


FIGURE 14. I²C Bus Data Transfer.



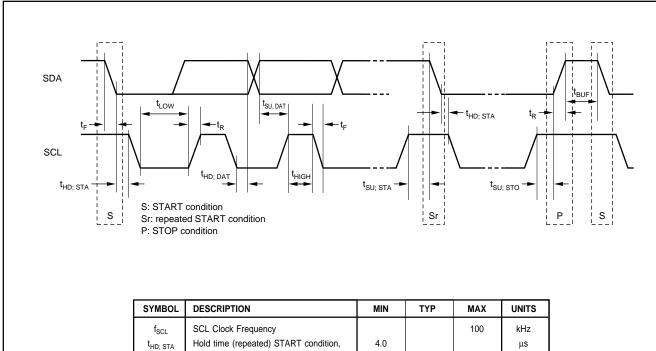
Data transfer begins with a Start condition, and is immediately followed by the Slave address and Read/Write bit. The Read/Write bit is set to "0" for the PCM1740, in order to write data to the control register specified by the subaddress. This is followed by an acknowledgment from the PCM1740, the sub-address (i.e., control register address), another acknowledgment from the PCM1740, the control register data, and another acknowledgment from the PCM1740. What happens after this depends upon if the user wants to continue writing additional control registers, or if they want to terminate the data transfer. If the user wants to continue, the acknowledgment is followed by a Start condi-

tion for the next write sequence. If the user decides to terminate the data transfer, then a Stop condition is generated by the Master.

The I²C-Bus specification defines timing requirements for devices connected to the bus. Timing requirements for the PCM1740 are shown in Figure 15.

Reference

For additional information regarding the I²C-Bus, please refer to the I²C-Bus Specification, Version 2.0, published in December 1998 by Philips Semiconductors.



SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
f _{SCL}	SCL Clock Frequency			100	kHz
t _{HD; STA}	Hold time (repeated) START condition,	4.0			μs
	after this period, the first clock pulse is generated				
t _{LOW}	LOW period of the SCL clock	4.7			μs
t _{HIGH}	HIGH period of the SCL clock	4.0			μs
t _{SU:STA}	Set-up time for a repeated START condition	4.7			μs
t _{HD;DAT}	Data hold time for I ² C-BUS devices	0		3.45(2)	μs
t _{SU;DAT}	Data set-up time	250			ns
t _R	Rise time of both SDA and SCL signals			1000	ns
t _F	Fall time of both SDA and SCL signals			300	ns
t _{SU;STO}	Set-up time for STOP condition	4.0			μs
t _{BUF}	Bus free time between a STOP and START condition	4.7			μs
C _B	Capacitive load for each bus line			400	pF
V_{NL}	Noise margin at the LOW level for each connected device (including hysteresis)	0.1 V _{DD}			V
V _{NH}	Noise margin at the HIGH level for each connected device (including hysteresis)	0.2 V _{DD}			V

FIGURE 15. I²C Bus Timing.

APPLICATIONS INFORMATION

Basic Connection Diagram

A basic connection diagram is shown in Figure 16. Power supply and reference de-coupling capacitors should be located as close as possible to the PCM1740 package. The 27MHz crystal should also be located as close as possible to the package, to reduce the effects of parasitic capacitance on VCXO operation.

A single +5V supply is recommended, to avoid issues with power-supply sequencing and SCR latch-up. It is recommended that this supply be separate from the system's digital power supply. In cases where this is not practical, an

inductor or ferrite bead should be placed in series with the +5V supply connection to reduce or eliminate high-frequency noise on the supply line.

In cases where overshoot or ringing is present on the LRCK or BCK signals, a series resistance of 25Ω to 100Ω should be added. The resistor forms a simple RC filter with the device input and PCB parasitic capacitance, dampening the overshoot and ringing effects, while reducing high-frequency noise emissions.

Typical Application Diagram

Figure 17 shows the PCM1740 being used as part of the audio sub-system in a set-top box application.

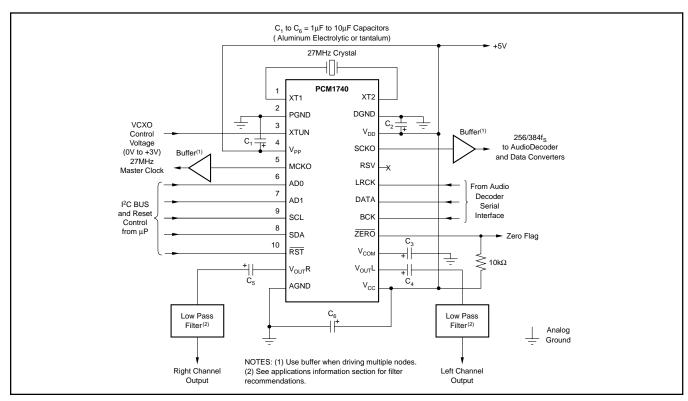


FIGURE 16. Basic Connection Diagram.

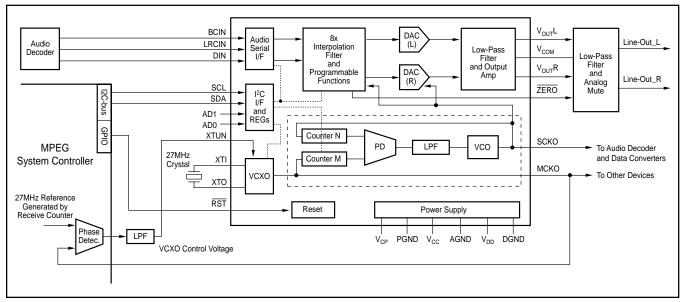


FIGURE 17. Typical Application Diagram.



The VTUN control voltage is generated by the MPEG-2 controller, which compares the MCKO output clock from the PCM1740 with the clock count received from the transmitter. VTUN is adjusted to retain clock synchronization between the transmitted and received signals. The SCKO output is used as the audio master clock for the audio decoder and additional data converters.

V_{COM} Output

The unbuffered DC common-mode voltage output, V_{COM} (pin 15), is brought out mainly for de-coupling purposes. V_{COM} is nominally biased to $V_{CC}/2$. The V_{COM} output may be used to bias external circuits, but it must be connected to a high-impedance node or buffered using a voltage follower. Figure 18 shows examples of the proper use of the V_{COM} output for external biasing applications.

DAC Output Filtering

Delta-Sigma D/A converters utilize noise shaping techniques to improve in-band signal-to-noise (SNR) performance at the expense of generating increased out of band noise above the Nyquist frequency, or $f_{\rm S}/2$. The out of band noise must be low-pass filtered in order to provide optimal converter performance. This is accomplished by a combination of on-chip and external low-pass filtering.

The PCM1740 includes an on-chip low-pass filter as part of the output amplifier stage. The frequency response for the filter is shown in the Typical Performance Curves section of this data sheet. The –3dB cutoff frequency is fixed at 100kHz.

Figure 19 shows the recommended external low-pass active filter circuits for dual and single-supply applications. These circuits are second-order Butterworth filters using the Multiple Feedback (MFB) circuit arrangement. Both filters have a cutoff frequency of 30kHz. Figure 19(a) is a dual-supply filter with a gain of 1.85 (for a standard 2 V_{RMS} line output level). Figure 19(b) is a single-supply filter with a gain of 1. Values for the filter components may be calculated using the FilterPro program, available from the Burr-Brown web site (www.burr-brown.com) and local sales offices. For more information regarding MFB active filter design and the FilterPro program, please refer to Burr-Brown Applications Bulletin, AB-034.

Since the overall system performance is defined primarily by the quality of the D/A converters and their associated analog output circuitry, op amps designed specifically for audio applications are recommended for the active filters. Burr-Brown's OPA2134, OPA2353, and OPA2343 dual op amps are ideal for use with the PCM1740.

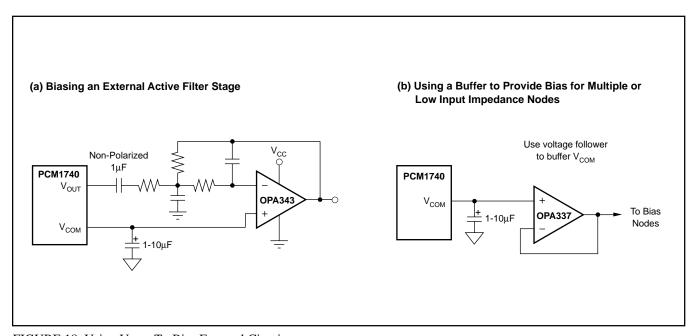


FIGURE 18. Using V_{COM} To Bias External Circuitry.

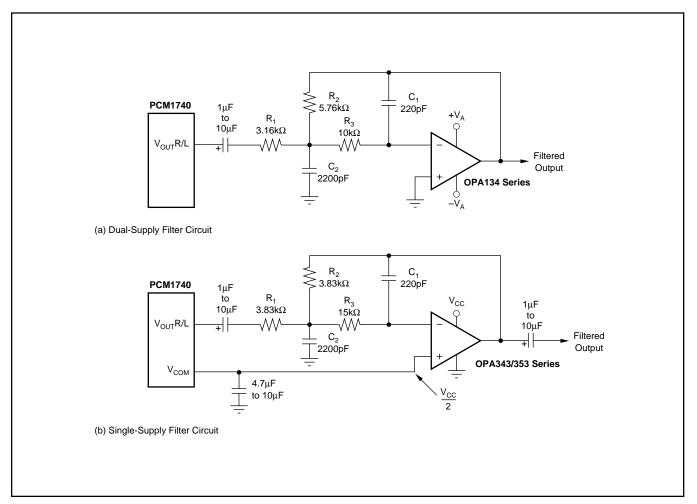


FIGURE 19. Recommended Output Filter Circuits.

PCM1740

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